Procedural Review Voting Sheet 2013 Cycle 7

REGION: Japan COMMITTEE: Silicon Wafer EVENT: SEMICON Japan 2013 DATE OF MEETING: 12/5/2013 PLACE OF MEETING: Makuhari Messe, Chiba, Japan COMMITTEE CO-CHAIRS: Tetsuya Nakai/SUMCO, Naoyuki Kawai/The University of Tokyo SEMI STAFF: Hirofumi Kanno

A&R Voter: Name/Company Date: 200X/MM/DD

I. Document Number & Title

Document	Document Title
5389A	Revision to MF1982-1110, Test Methods for
	Analyzing Organic Contaminants on Silicon Wafer
	Surfaces by Thermal Desorption Gas
	Chromatography

II. Tally (Staff to fill in)

Voting Tally: As-cast tally after close of voting period

A minimum of 60% of the voting interests that have voting members within the technical committee must return votes. (Regulations \P 9.6.1)

	Return	Di	stribution	1	Return Rat	e
Yellow	56] ÷ 🗌	91	=	61.5%	>=60%
Lilac & Others	36]				
Total Vote	92]				
Reject	0]				
Accept	21]				

A&R	Not approved
	Reason:

III. Rejects

IV. Comments

Comment 1

		men							
	Referenced Section			*TF/Committee to fill in if necessary					
Comment	From			Kurt Haler (KLA-Tencor)					
	Comment			Accept with comment: Editorial: Formatted text for Cn definition is unreadable. Letters overlap each other. The unformatted text, extracted from the pdf document, reads: 'C onarebsounrfnaucme abreera=o1f 6thoerw2a0fer sample, cm2.'					
	[ussion						
	x	The	e commit	tee agreed to do one of the following actions.					
	~	*No	o motion i	is required in this step.					
		Х	No furthe	er action was taken by the committee.					
				the task force for more consideration.					
			New Bus	siness					
			Other						
Acti	Editorial Change		Case 1:	No vote in this section :					
Action proposed			To be included and voted on in § 5. Summary of Editorial Changes.						
opc				Voted in this section :					
sed				section number and at least one full sentence are required in "FROM" and					
		FF	FROM:	Section xxx					
		1	To: Section xxx						
				ation (If necessary)					
		2	FROM:	Section xxx					
		-	To Soo	tion xxx					

Justification (If necessary)								
Motion by/2nd		nd Friedrich Passek (Siltronic) / Mike Goldstein (Intel)						
Vote		14-0 Motion passed						
A&R		Not approved						
Adr	Reason:							

V. Summary of Editorial Changes

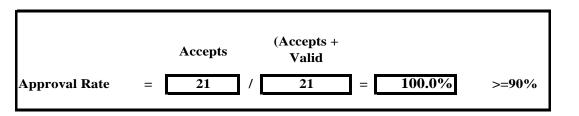
None

VI. Approval Conditions Check

APPROVAL CONDITION 1: All negatives have been discussed and were withdrawn, found not related, or not persuasive. (Regulations \P 9.6.2)

APPROVAL CONDITION 2: At least 90% of the sum of the valid accept and reject votes must be accept. (Regulations \P 9.6.3)

Note: if both approval conditions are not satisfied, the document fails.



A&R	Not approved
AGIN	Reason:

VII. Safety Check

See § 14 of the Regulations for further information

7	х	Th stil	This is not a Safety Document: when all safety-related information is removed, the document is still technically sound and complete.						
Motion:		This is a Safety Document: when all safety-related information is removed, the document is not technically sound and complete.							
			Safety Checklist (Regulations ¶ 14.3) is complete and has been included with the document throughout the balloting process.						
Ν	/loti	on b	y/2nd by	Ryuji Takeda (GlobalWafers japan)/ Mike Goldstein (Intel)					
Discussion		ission	None						
Vote			ote	16-0 Motion passed					
	A&F	O	Not a	oproved					
Ad			Reason:						

VIII. Intellectual Property Check

	he meeting chair asked those present in person or by electronic link, if they were aware of any otentially material patented technology or copyrighted items* in the Standard or Guideline.						
Х		GO TO SECTION IX					
	know	vn but a Lei	tter of A	Assurance (LOA) or copyright release for	GO TO SECTION IX		
	сору	ntially material patented technology or copyrighted items are known but an LOA or right release for some of the material(s) has NOT been obtained or presented to the mittee					
M		Ask ISC f	for special permission to publish				
ΟΤΙΟ		Quit activ	activity				
ž		Wait for L	_OA for patented technology or release of copyrighted items.				
Мо	tion by	y/2 nd by	Name (Company)/Name (Company)				
6	Discus	sion	XXXX				
	Vot	e	XX-XX				
	:	otion	Motion Passed				
F	inal A	CUON	Motion Failed				
م 0		Not appro	oved				
&R Reason:							
	Mo Tio Mo E K R	to the entire The meetin potentially r X No p are k Pote know such Pote copy com Motion by Discus Vot Final A & Reas	to the entire Standard The meeting chair ask potentially material parts are known X No potentially material parts are known X No potentially material parts are known X Potentially material parts are known Potentially material parts are known Potentially material parts are known Potentially material parts are known but a Let such material has bus are copyright release committee Potentially material parts are known Potentially material parts are known but a Let such material has bus are copyright release committee Ask ISC for Quit active Motion by/2 nd by Discussion Vote Final Action &R Not appro	to the entire Standard or Safe The meeting chair asked those potentially material patented to spotentially material patented to the spotential totthe spotential to the spotential to the spote	potentially material patented technology or copyrighted items* in the Stand X No potentially material patented technology or copyrighted items are known Potentially material patented technology or copyrighted items are known but a Letter of Assurance (LOA) or copyright elease for such material has been obtained or presented to the committee. Potentially material patented technology or copyrighted items are kn copyright release for some of the material(s) has NOT been obtained committee Motion by/2 nd by Name (Company)/Name (Company) Discussion XXXX Vote XX-XX Final Action Motion Passed Not approved Not approved		

* Note: Such potentially material patented technology or copyrighted items might have become known since the Standard or Safety Guideline was last reviewed, or might become relevant due to this ballot.

IX. Action for this document

	x		This document passed committee review as balloted and will be forwarded to the A&R for procedural review.									
Motion		This document passed committee review with editorial changes and will be forwarded to the A&R for procedural review.										
		This document failed committee review and will be returned to the task force for rework.										
		Th	is do	ocun	nent failed committee review and work will be discontinued.							
Γ	Motion by/2nd by			d	Ryuji Takeda (GlobalWafers Japan)/Fredrich Passek (Siltronic)							
	Dis	cus	sion		None							
		Vote	e		16-0							
	Fins	ما اد	ctior	,	X Motion passed							
	1 1110				Motion failed							
				Ар	proved							
	A&F	२		No	t approved							
		Reason:										